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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	32
Program Memory Size	4KB (4K x 8)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-BSSOP (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323lah4804c

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Development Features

Table 1 lists the features of $ZiLOG^{(R)}$'s Z8 GP^{TM} OTP MCU Family family members.

Table 1. Features

Device	OTP (KB)	RAM (Bytes)	I/O Lines	Voltage Range
ZGP323L OTP MCU Family	4, 8, 16, 32	237	32, 24 or 16	2.0V–3.6V

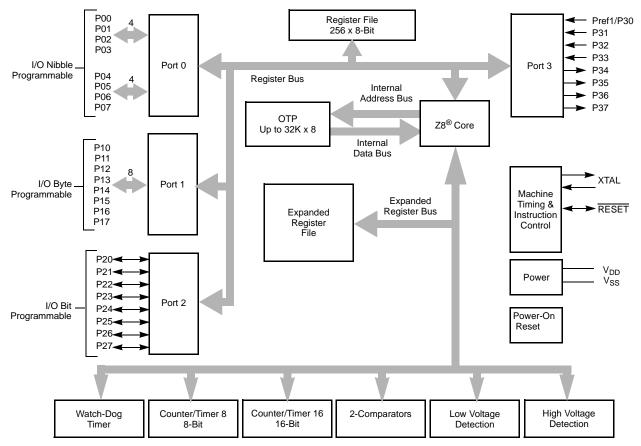
- Low power consumption–6mW (typical)
- T = Temperature
 - S = Standard 0° to +70°C
 - $E = Extended 40^{\circ} to + 105^{\circ}C$
 - A = Automotive -40° to $+125^{\circ}$ C
- Three standby modes:
 - STOP-2µA (typical)
 - HALT-0.8mA (typical)
 - Low voltage reset
- Special architecture to automate both generation and reception of complex pulses or signals:
 - One programmable 8-bit counter/timer with two capture registers and two load registers
 - One programmable 16-bit counter/timer with one 16-bit capture register pair and one 16-bit load register pair
 - Programmable input glitch filter for pulse reception
- Six priority interrupts
 - Three external
 - Two assigned to counter/timers
 - One low-voltage detection interrupt
- Low voltage detection and high voltage detection flags
- Programmable Watch-Dog Timer/Power-On Reset (WDT/POR) circuits
- Two independent comparators with programmable interrupt polarity
- Programmable EPROM options
 - Port 0: 0–3 pull-up transistors
 - Port 0: 4–7 pull-up transistors

Z8 GPTM OTP MCU Family Product Specification



Table 2. Power Connections

Connection	Circuit	Device	
Power	V _{CC}	V _{DD}	
Ground	GND	V _{SS}	



Note: Refer to the specific package for available pins.

Figure 1. Functional Block Diagram

Z8 GPTM OTP MCU Family Product Specification



	i				
			\bigcirc	40	
NC		1		48	I NC
P25	С	2		47	I NC
P26		3		46	I P24
P27		4		45	P23
P04		5		44	P22
N/C		6		43	I P21
P05		7		42	I P20
P06		8		41	P03
P14		9		40	I P13
P15		10		39	I P12
P07		11	40 Dia	38	VSS
VDD		12	48-Pin SSOP	37	VSS
VDD		13	330F	36	N/C
N/C		14		35	P02
P16		15		34	I P11
P17		16		33 =	I P10
XTAL2		17		32	P01
XTAL1		18		31	I P00
P31		19		30	N/C
P32		20		29	PREF1/P30
P33		21		28	P36
P34		22		27	I P37
NC		23		26	I P35
VSS		24		25	RESET

Figure 6. 48-Pin SSOP Pin Configuration

Table 5. 40- and 48-Pin Configuration

40-Pin PDIP/CDIP* #	48-Pin SSOP #	Symbol
26	31	P00
27	32	P01
30	35	P02
34	41	P03
5	5	P04
6	7	P05
7	8	P06
10	11	P07
28	33	P10
29	34	P11
32	39	P12

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			T _A = 0°	C to +	70°C			
Symbol	Parameter	V _{CC}	Min	Тур	Max	Units	Conditions	Notes
I _{CC1}	Standby Current	2.0			3	mA	$V_{IN} = 0V, V_{CC}$ at 8.0MHz	1, 2
	(HALT Mode)	3.6			5		Same as above	1, 2
		2.0			2		Clock Divide-by-16 at 8.0MHz	1, 2
		3.6			4		Same as above	1, 2
I _{CC2}	Standby Current (Stop	2.0			8	μΑ	V _{IN} = 0 V, V _{CC} WDT is not Running	3
	Mode)	3.6			10	μA	Same as above	3
		2.0			500	μΑ	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		3.6			800	μA	Same as above	3
I _{LV}	Standby Current				10	μΑ	Measured at 1.3V	4
	(Low Voltage)							
V _{BO}	V _{CC} Low Voltage				2.0	V	8MHz maximum	
20	Protection						Ext. CLK Freq.	
V _{LVD}	Vcc Low Voltage			2.4		V		
212	Detection							
V _{HVD}	Vcc High Voltage			2.7		V		
	Detection							
Notos:								

Table 8. DC Characteristics (Continued)

Notes:

1. All outputs unloaded, inputs at rail.

2. CL1 = CL2 = 100 pF.

3. Oscillator stopped.

4. Oscillator stops when V_{CC} falls below V_{BO} limit. 5. It is strongly recommended to add a filter capacitor (minimum 0.1 μ F), physically close to the V_{DD} and V_{SS} pins if operating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.



Pin Functions

XTAL1 Crystal 1 (Time-Based Input)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator input. Additionally, an optional external single-phase clock can be coded to the on-chip oscillator input.

XTAL2 Crystal 2 (Time-Based Output)

This pin connects a parallel-resonant crystal or ceramic resonant to the on-chip oscillator output.

Port 0 (P07-P00)

Port 0 is an 8-bit, bidirectional, CMOS-compatible port. These eight I/O lines are configured under software control as a nibble I/O port. The output drivers are push-pull or open-drain controlled by bit D2 in the PCON register.

If one or both nibbles are needed for I/O operation, they must be configured by writing to the Port 0 mode register. After a hardware reset, Port 0 is configured as an input port.

An optional pull-up transistor is available as a mask option on all Port 0 bits with nibble select.

Notes: Internal pull-ups are disabled on any given pin or group of port pins when programmed into output mode.

The Port 0 direction is reset to be input following an SMR.





Figure 9. Port 0 Configuration

Port 1 (P17–P10)

Port 1 (see Figure 10) Port 1 can be configured for standard port input or output mode. After POR, Port 1 is configured as an input port. The output drivers are either push-pull or open-drain and are controlled by bit D1 in the PCON register.



Note: The Port 1 direction is reset to be input following an SMR.



The counter/timers are mapped into ERF group D. Access is easily performed using the following:

LD	RP, #0Dh	;	Select ERF D
for access to bank D			
		;	(working
register group 0)			
LD	R0,#xx	;	load CTRL0
LD	1, #xx	;	load CTRL1
LD	R1, 2	;	$CTRL2 \rightarrow CTRL1$
LD	RP, #0Dh	;	Select ERF D
for access to bank D	,	,	
		;	(working
register group 0)			
LD	RP, #7Dh	;	Select
expanded register bank	D and working	;	register
group 7 of bank 0 for a	ccess.		
LD	71h, 2		
; CTRL2 \rightarrow register 71h			
LD	R1, 2		
; CTRL2 \rightarrow register 71h			

Register File

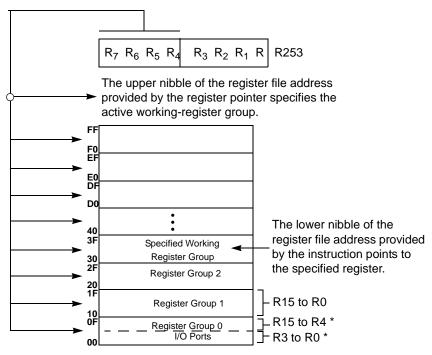
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The register file (bank 0) consists of 4 I/O port registers, 237 general-purpose registers, 16 control and status registers (R0–R3, R4–R239, and R240–R255, respectively), and two expanded registers groups in Banks D (see Table 12) and F. Instructions can access registers directly or indirectly through an 8-bit address field, thereby allowing a short, 4-bit register address to use the Register Pointer (Figure 17). In the 4-bit mode, the register file is divided into 16 working register groups, each occupying 16 continuous locations. The Register Pointer addresses the starting location of the active working register group.









* RP = 00: Selects Register Bank 0, Working Register Group 0

Figure 17. Register Pointer—Detail

Stack

The internal register file is used for the stack. An 8-bit Stack Pointer SPL (R255) is used for the internal stack that resides in the general-purpose registers (R4–R239). SPH (R254) can be used as a general-purpose register.





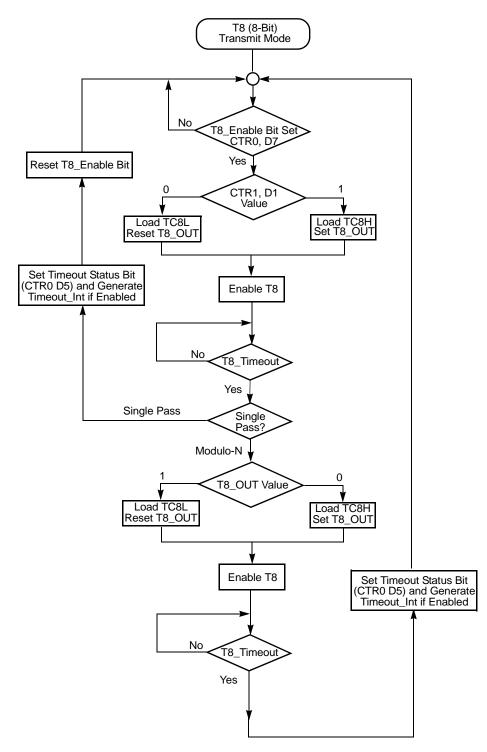


Figure 19. Transmit Mode Flowchart



When T8 is enabled, the output T8_OUT switches to the initial value (CTR1, D1). If the initial value (CTR1, D1) is 0, TC8L is loaded; otherwise, TC8H is loaded into the counter. In SINGLE-PASS Mode (CTR0, D6), T8 counts down to 0 and stops, T8_OUT toggles, the timeout status bit (CTR0, D5) is set, and a timeout interrupt can be generated if it is enabled (CTR0, D1). In Modulo-N Mode, upon reaching terminal count, T8_OUT is toggled, but no interrupt is generated. From that point, T8 loads a new count (if the T8_OUT level now is 0), TC8L is loaded; if it is 1, TC8H is loaded. T8 counts down to 0, toggles T8_OUT, and sets the timeout status bit (CTR0, D5), thereby generating an interrupt if enabled (CTR0, D1). One cycle is thus completed. T8 then loads from TC8H or TC8L according to the T8_OUT level and repeats the cycle. See Figure 20.

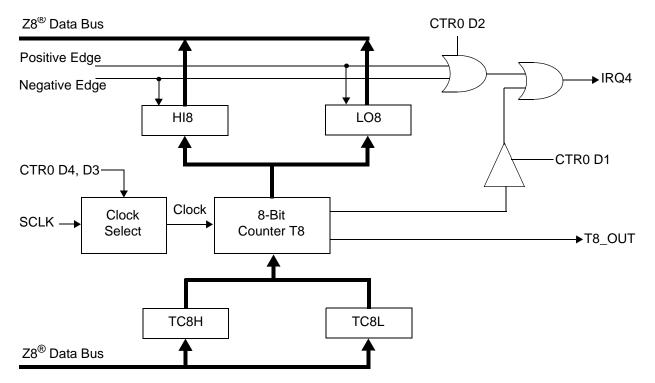


Figure 20. 8-Bit Counter/Timer Circuits

You can modify the values in TC8H or TC8L at any time. The new values take effect when they are loaded.

Ca

Caution: To ensure known operation do not write these registers at the time the values are to be loaded into the counter/timer. *An initial count of 1 is not allowed (a non-function occurs).* An initial count of 0 causes TC8 to count from 0 to FFH to FEH.

Z8 GP[™] OTP MCU Family Product Specification



Caution: Do not load these registers at the time the values are to be loaded into the counter/timer to ensure known operation. An initial count of 1 is not allowed. An initial count of 0 causes T16 to count from 0 to FFFFH to FFFFH. Transition from 0 to FFFFH is not a timeout condition.







Figure 27. T16_OUT in Modulo-N Mode

T16 DEMODULATION Mode

The user must program TC16L and TC16H to FFH. After T16 is enabled, and the first edge (rising, falling, or both depending on CTR1 D5; D4) is detected, T16 captures HI16 and LO16, reloads, and begins counting.

If D6 of CTR2 Is 0

When a subsequent edge (rising, falling, or both depending on CTR1, D5; D4) is detected during counting, the current count in T16 is complemented and put into HI16 and LO16. When data is captured, one of the edge detect status bits (CTR1, D1; D0) is set, and an interrupt is generated if enabled (CTR2, D2). T16 is loaded with FFFFH and starts again.

This T16 mode is generally used to measure space time, the length of time between bursts of carrier signal (marks).



Name	Source	Vector Location	Comments
IRQ0	P32	0,1	External (P32), Rising, Falling Edge Triggered
IRQ1	P33	2,3	External (P33), Falling Edge Triggered
IRQ2	P31, T _{IN}	4,5	External (P31), Rising, Falling Edge Triggered
IRQ3	T16	6,7	Internal
IRQ4	Т8	8,9	Internal
IRQ5	LVD	10,11	Internal

Table 16. Interrupt Types, Sources, and Vectors

When more than one interrupt is pending, priorities are resolved by a programmable priority encoder controlled by the Interrupt Priority Register. An interrupt machine cycle activates when an interrupt request is granted. As a result, all subsequent interrupts are disabled, and the Program Counter and Status Flags are saved. The cycle then branches to the program memory vector location reserved for that interrupt. All Z8 GPTM OTP MCU Family interrupts are vectored through locations in the program memory. This memory location and the next byte contain the 16-bit address of the interrupt service routine for that particular interrupt request. To accommodate polled interrupt systems, interrupt inputs are masked, and the Interrupt Request register is polled to determine which of the interrupt requests require service.

An interrupt resulting from AN1 is mapped into IRQ2, and an interrupt from AN2 is mapped into IRQ0. Interrupts IRQ2 and IRQ0 can be rising, falling, or both edge triggered. These interrupts are programmable by the user. The software can poll to identify the state of the pin.

Programming bits for the Interrupt Edge Select are located in the IRQ Register (R250), bits D7 and D6. The configuration is indicated in Table 17.

IRQ		Interr	Interrupt Edge			
D7	D6	IRQ2 (P31)	IRQ0 (P32)			
0	0	F	F			
0	1	F	R			
1	0	R	F			
1	1	R/F	R/F			
Note: F = Falling Edge; R = Rising Edge						

Table 17. IRQ Register

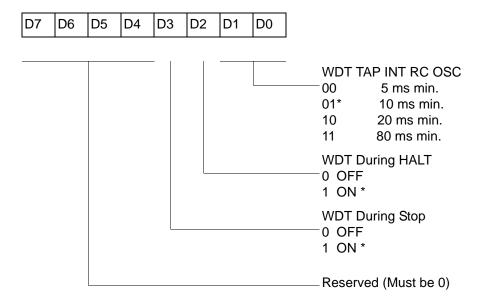


Watch-Dog Timer Mode Register (WDTMR)

The Watch-Dog Timer (WDT) is a retriggerable one-shot timer that resets the Z8[®] CPU if it reaches its terminal count. The WDT must initially be enabled by executing the WDT instruction. On subsequent executions of the WDT instruction, the WDT is refreshed. The WDT circuit is driven by an on-board RC-oscillator. The WDT instruction affects the Zero (Z), Sign (S), and Overflow (V) flags.

The POR clock source the internal RC-oscillator. Bits 0 and 1 of the WDT register control a tap circuit that determines the minimum timeout period. Bit 2 determines whether the WDT is active during HALT, and Bit 3 determines WDT activity during Stop. Bits 4 through 7 are reserved (Figure 37). This register is accessible only during the first 60 processor cycles (120 XTAL clocks) from the execution of the first instruction after Power-On-Reset, Watch-Dog Reset, or a Stop-Mode Recovery (Figure 36). After this point, the register cannot be modified by any means (intentional or otherwise). The WDTMR cannot be read. The register is located in Bank F of the Expanded Register Group at address location 0Fh. It is organized as shown in Figure 37.

WDTMR(0F)0Fh



* Default setting after reset

Figure 37. Watch-Dog Timer Mode Register (Write Only)

WDT Time Select (D0, D1)

This bit selects the WDT time period. It is configured as indicated in Table 20.



WDTMR During STOP (D3)

This bit determines whether or not the WDT is active during STOP Mode. Because the XTAL clock is stopped during STOP Mode, the on-board RC has to be selected as the clock source to the WDT/POR counter. A 1 indicates active during Stop. The default is 1.

EPROM Selectable Options

There are seven EPROM Selectable Options to choose from based on ROM code requirements. These options are listed in Table 21.

Table 21. EPROM Selectable Options

Port 00–03 Pull-Ups	On/Off
Port 04–07 Pull-Ups	On/Off
Port 10–13 Pull-Ups	On/Off
Port 14–17 Pull-Ups	On/Off
Port 20–27 Pull-Ups	On/Off
EPROM Protection	On/Off
Watch-Dog Timer at Power-On Reset	On/Off

Voltage Brown-Out/Standby

An on-chip Voltage Comparator checks that the V_{DD} is at the required level for correct operation of the device. Reset is globally driven when V_{DD} falls below V_{BO}. A small drop in V_{DD} causes the XTAL1 and XTAL2 circuitry to stop the crystal or resonator clock. If the V_{DD} is allowed to stay above V_{RAM}, the RAM content is preserved. When the power level is returned to above V_{BO}, the device performs a POR and functions normally.



Low-Voltage Detection Register—LVD(D)0Ch

Note: Voltage detection does not work at Stop mode. It must be disabled during Stop mode in order to reduce current.

Field	Bit Position			Description
LVD	76543			Reserved No Effect
	2	R	1 0*	HVD flag set HVD flag reset
	1-	R	1 0*	LVD flag set LVD flag reset
	0	R/W	1 0*	Enable VD Disable VD
*Default	after POR			

Note: Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

Voltage Detection and Flags

The Voltage Detection register (LVD, register 0CH at the expanded register bank 0Dh) offers an option of monitoring the V_{CC} voltage. The Voltage Detection is enabled when bit 0 of LVD register is set. Once Voltage Detection is enabled, the the V_{CC} level is monitored in real time. The flags in the LVD register valid 20uS after Voltage Detection is enabled. The HVD flag (bit 2 of the LVD register) is set only if V_{CC} is higher than V_{HVD}. The LVD flag (bit 1 of the LVD register) is set only if V_{CC} is lower than the V_{LVD}. When Voltage Detection is enabled, the LVD flag also triggers IRQ5. The IRQ bit 5 latches the low voltage condition until it is cleared by instructions or reset. The IRQ5 interrupt is served if it is enabled in the IMR register. Otherwise, bit 5 of IRQ register is latched as a flag only.

Notes: If it is necessary to receive an LVD interrupt upon power-up at an operating voltage lower than the low battery detect threshold, enable interrupts using the Enable Interrupt instruction (EI) prior to enabling the voltage detection.



Expanded Register File Control Registers (0D)

The expanded register file control registers (0D) are depicted in Figure 39 through Figure 43.

CTR0(0D)00H



* Default setting after reset

**Default setting after reset. Not reset with Stop Mode recovery.

Figure 39. TC8 Control Register ((0D)O0H: Read/Write Except Where Noted)



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R249 IPR(F9H)

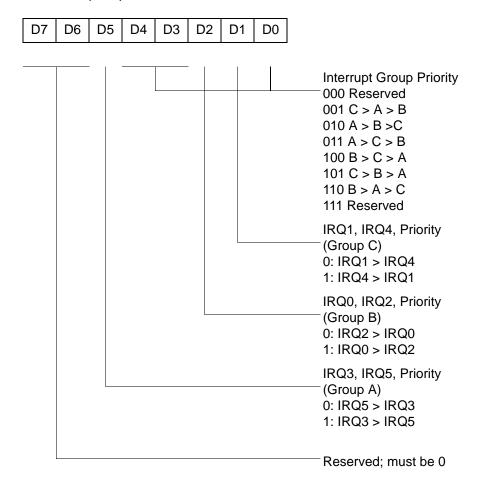


Figure 51. Interrupt Priority Register (F9H: Write Only)



R254 SPH(FEH)



General-Purpose Register

Figure 56. Stack Pointer High (FEH: Read/Write)

R255 SPL(FFH)

D7	D6	D5	D4	D3	D2	D1	D0
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Stack Pointer Low Byte (SP7–SP0)

Figure 57. Stack Pointer Low (FFH: Read/Write)











Figure 59. 20-Pin PDIP Package Diagram



CONTROLLING DIMENSIONS : INCH



Figure 60. 20-Pin SOIC Package Diagram

SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
А	2.40	2.65	.094	.104
A1	0.10	0.30	.004	.012
A2	2.24	2.44	.088	.096
в	0.36	0.46	.014	.018
С	0.23	0.30	.009	.012
D	12.60	12.95	.496	.510
E	7.40	7.60	.291	.299
e	1.27 BSC		.050 BSC	
н	10.00	10.65	.394	.419
h	0.30	0.40	.012	.016
L	0.60	1.00	.024	.039
Q1	0.97	1.07	.038	.042

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Codes

ZG = ZiLOG General Purpose Family

P = OTP

- 323 = Family Designation
- L = Voltage Range

2V to 3.6V

T = Temperature Range:

S = 0 to 70 degrees C (Standard)

- E = -40 to +105 degrees C (Extended)
- A = -40 to +125 degrees C (Automotive)
- P = Package Type:
 - K = Windowed Cerdip
 - P = PDIP
 - H = SSOP
 - S = SOIC
- ## = Number of Pins
- CC = Memory Size
- M = Packaging Options
 - C = Non Lead-Free
 - G = Lead-Free
 - E = CDIP